TYS50403R3N-10

PHYSICAL DIMENSIONS:

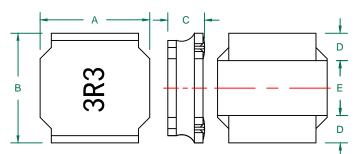
 $A 5.00 \pm 0.20$

B 5.00 ± 0.20

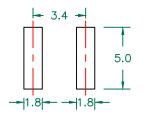
C 4.00 ± 0.20

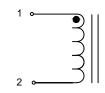
 $D 1.60 \pm 0.30$

E 1.80 ± 0.30



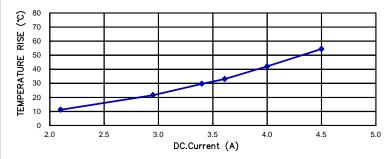
LAND PATTERNS FOR REFLOW SOLDERING



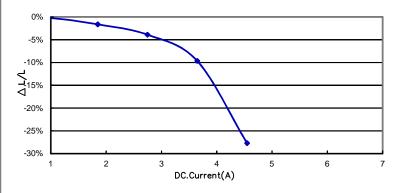




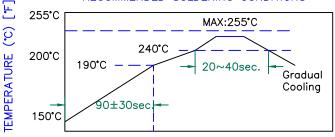
CHARACTERISTICS OF TEMPERATURE RISE



CURRENT VS INDUCTANCE DROP IN RATES



RECOMMENDED SOLDERING CONDITIONS



ELECTRICAL SPECIFICATION

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 30%	2.31	3.30	4.29
DCR (Ω)		0.024	0.0288

Saturation Current(A)	3.95
SRF (MHz)	32
Temperature Rise Current (A)	3.40

NOTES: UNLESS OTHERWISE SPECIFIED

1.OPERATING TEMPERATURE RANGE: -40°C TO +125°C (INCLUDING SELF-HEATING) .

2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)

3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS: A. AMBIENT TEMPERATURE: 20±15°C.

B. RELATIVE HUMIDITY: 65%±20%.

4.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS ≤30% FROM ITS VALUE WITHOUT CURRENT.

5.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 20°C AMBIENT.

DIMENSIONS ARE IN mm .			This print is the property of Laird					
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				rights to design or invention are reserved.				
D	CHANGE LAND PATTERNS	09/29/17	OILL	PROJECT/PART NUMBER:	REV	PART T	YPE:	DRAWN BY:
C	MODIFY "C,D,E"	04/26/16		TYS50403R3N-10	D		WER	QIU
В	CHANGE TEMP FROM -25℃~+125℃	12/21/12	QIU	DATE: 05 /74 /40 ISC			SHEET:	
Α	ORIGINAL DRAFT	05/31/12	QIU	O5/31/12	NTS		ļ	
REV	DESCRIPTION	DATE	INT	TYS50403R3N-10-D	TOOL #	-	1	of 1

Mouser Electronics

Authorized Distributor

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Laird Performance Materials:

TYS50403R3N-10